



Product name	Confidentiality level
E173	Secret
Product version	Total 5 pages
V100R001	

Huawei E173 Release Notes

Prepared by 6290 Team Date 2013-10-15
Reviewed by 6290 Team Date 2013-10-15



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Revision record

Date	Revision version	change Description	Author
2013-10-15	V1.0	Firmware updated	6290 Team



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Huawei E173 Release Notes

1 Information

1.1 Base Specifications

Information	
Item	Specifications
Technical standard	<ul style="list-style-type: none">• WCDMA/HSDPA R5• HSUPA R6• GSM/GPRS/EGPRS R99

2 Firmware

2.1 Specifications

Firmware		
Item	Specifications	
Version	11.126.31.00.1212	
SMS	PS & CS domain support	
Qualcomm Information	Platform	MSM6290
	Baseline	M6290AKPRBL220050
	Feature	HSPA Supported
Data service	GSM CS domain	<ul style="list-style-type: none">• Uplink: 9.6/14.4 kbit/s• Downlink: 9.6/14.4 kbit/s
	GPRS	<ul style="list-style-type: none">• Uplink: 85.6 kbit/s• Downlink: 85.6 kbit/s
	EDGE	<ul style="list-style-type: none">• Uplink: 236.8 kbit/s• Downlink: 236.8 kbit/s
	UMTS PS domain	<ul style="list-style-type: none">• Uplink: 384 kbit/s• Downlink: 384 kbit/s
	UMTS CS domain	<ul style="list-style-type: none">• Uplink: 64 kbit/s• Downlink: 64 kbit/s
	HSDPA	<ul style="list-style-type: none">• 7.2Mbit/s



Firmware		
Item	Specifications	
	HSUPA	• 5.76 Mbit/s
	•	

2.2 Improvement in the previous version

Firmware	
Defect No.	Defect Description
None.	None.

2.3 Known limitations and issues

Firmware	
Limitation No.	Limitation Description
None.	None.